

4-Bit Bidirectional Voltage-Level Translator

1 Features

- No direction-control
- Data rates
 24 Mbps (Push Pull), 2 Mbps
 (Open Drain)
- 1.65 V to 3.6 V on A port and 2.3 V to 5.5 V on B port(V_{CCA} ≤ V_{CCB})
- V_{CC} isolation feature: if either V_{CC} input is at GND, both ports are in the high-impedance state
- No power-supply sequencing required: either V_{CCA} or V_{CCB} can be ramped first
- I_{off} supports partial-power-down mode operation
- Operating temperature range:-40 ℃ to +85 ℃ V

2 Application

- ♦ Handset/Smartphone
- UART
- ◆ GPIO
- ◆ IPC

3 Description

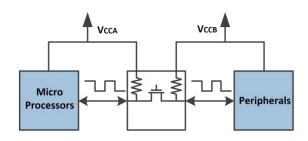
This 4-bit non-inverting translator is a bidirectional voltage-level translator and can be used to build digital switching compatibility

between multi voltage systems. It uses two separate configurable power supply rails that including A ports supporting operating voltages from 1.65 V to 3.6 V with tracking $V_{\rm CCA}$ supply, and also including B ports supporting operating voltages from 2.3 V to 5.5 V with tracking $V_{\rm CCB}$ supply.

The advantage above provides the support of both lower and higher logic signal levels while providing bidirectional translation capabilities between any of the 1.8-V, 2.5-V, 3.3-V, and 5- V voltage circuit points.

Placing output-enable (OE) input to low level, all I/Os are forced to high-impedance state that significantly lower the quiescent current consumption. In order to ensure the high-impedance state during power up or power down, OE pin should be tied to GND via a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

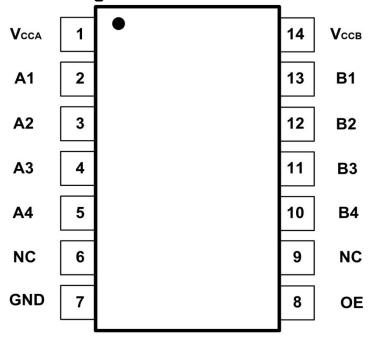
4 Circuit diagram





WB0104 waferbest 4-Bit Bidirectional Voltage-Level Translator

5 Device Pin and Packages



Name	Pin	I/O	Function			
V_{CCA}	1	-	A Port Supply Voltage. 1.65V≤V _{CCA} ≤3.6V and V _{CCA} ≤V _{CCB}			
A1	2	I/O	Input/Output A1. Referenced to V _{CCA} .			
A2	3	I/O	Input/Output A2. Referenced to V _{CCA} .			
A3	4	I/O	Input/Output A3. Referenced to V _{CCA} .			
A4	5	I/O	Input/Output A4. Referenced to V _{CCA} .			
NC	6	-	No internal connection			
GND	7	-	Ground			
OE	8	I	Output Enable(Active High).Pull OE low to place all outputs in 3-state mode.Referenced to V _{CCA} .			
NC	9	-	No internal connection			
B4	10	I/O	Input/Output B4. Referenced to V _{CCB} .			
В3	11	I/O	Input/Output B3. Referenced to V _{CCB} .			
B2	12	I/O	Input/Output B2. Referenced to V _{CCB} .			
B1	13	I/O	Input/Output B1. Referenced to V _{CCB} .			
V _{CCB}	14	-	B Port Supply Voltage. 2.3V≤V _{CCB} ≤5.5V			

^{*} It is suggested to leave the unconnected pins floating.



4-Bit Bidirectional Voltage-Level Translator

6 Voltage, Temperature, ESD and Thermal Ratings

6.1 Absolute Maximum Ratings⁽¹⁾⁽²⁾⁽³⁾

Parameters		Min	Max	Unit
Supply voltage, V _{CCA}	-0.3	6.0	V	
Supply voltage, V _{CCB}		-0.3	6.0	V
Input voltage range V	A port	-0.3	6.0	V
Input voltage range,V _I	B port	-0.3	6.0	V
Voltage range applied to any output in the high-impedance or power-	A port	-0.3	6.0	V
off state, V ₀	B port	-0.3	6.0	V
Voltage range applied to any output in the high or low state, V _O	A port	-0.3	V _{CCA} +0.3	V
voltage range applied to any output in the high or low state, vo	B port	-0.3	V _{CCA} +0.3	V
Input clamp current,I _{IK}	$V_I < 0$		-50	mA
Output clamp current,I _{OK}	V _O <0		-50	mA
Continuous output current,Io			±50	mA
Continuous current through V _{CCA} ,V _{CCB} or GND		±100	mA	
Maximum junction temperature		150	°C	
Storage temperature range		-65	150	°C

⁽¹⁾Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

6.2 ESD Ratings

	ES	Value	Unit	
		Human-Body Model (HBM) ⁽¹⁾	±5K	V
V(ESD)	Electrostatic discharge	Charged-Device Model (CDM) ⁽²)	±2K	V

⁽¹⁾ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

⁽³⁾ The value of V_{CCA} and V_{CCB} are provided in the recommended operating conditions table.

⁽²⁾ JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



4-Bit Bidirectional Voltage-Level Translator

6.3 Recommended Operating Conditions

 V_{CCI} is the supply voltage associated with the input port. V_{CCO} is the supply Voltage associated with the output port.

Parameter	Conditions		Min	Тур	Max	Unit
O 1 11 (1)		1.65		3.6		
Supply voltage ⁽¹⁾		V _{CCB}	2.3		5.5	V
		V _{CCA} =1.65V to 1.95V				
	A-port	V_{CCB} =2.3 V to 5.5 V	V _{CCI} -0.2		Vccı	
	I/Os	V _{CCA} =2.3 V to 3.6 V				
High-level		V_{CCB} =2.3 V to 5.5 V	V _{CCI} -0.4		Vccı	
input voltage(V _{IH})	B-port	V _{CCA} =1.65 V to 3.6V				V
3 (,	I/Os	V_{CCB} =2.3 V to 5.5 V	V _{CCI} -0.4		V _{CCI}	
	0.5	V _{CCA} =1.65 V to 3.6 V				
	OE input	V_{CCB} =2.3 V to 5.5 V	V _{CCI} ×0.8		5.5	
	A-port	V _{CCA} =1.65 V to 1.95 V				
	I/Os	V_{CCB} =2.3 V to 5.5 V	0		0.15	.,
Low-level	B-port	B-port V _{CCA} = 1.65 V to 3.6 V				V
input voltage(V _{IL}) ⁽²⁾	I/Os	V_{CCB} =2.3 V to 5.5 V	0		0.15	
	OE	V _{CCA} =1.65 V to 3.6 V				
	input	V_{CCB} =2.3 V to 5.5 V	0		V _{CCA} ×0.25	V
	A-	port I/Os push-pull driving			10	
Input transition rise	B-port I/Os push-pull driving				10	ns/V
or fall rate(Δt/Δv)				10		
TA operating free-air						
temperature			-40		85	°C

⁽¹⁾ V_{CCA} must be less than or equal to V_{CCB} .

⁽²⁾ The maximum V_{IL} value is provided to ensure that a valid V_{OL} is maintained. The V_{OL} value is V_{IL} plus the voltage drop across the pass gate transistor.



4-Bit Bidirectional Voltage-Level Translator

7 Electrical Specifications

7.1 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (1) (2)

Para	meter	Conditions	Vcca	Vccв	Temp	Min	Тур	Max	Unit			
V _{OHA}	Port A Output High Voltage	I _{OH} = −20 μA V _{IB} ≥ V _{CCB} − 0.4V	1.65V to 3.6V	2.3V to 5.5V	Full	V _{CCA} ×0.7			V			
V _{OLA}	Port A Output Low Voltage	I_{OL} = 1 mA $V_{IB} \le 0.15 \text{ V}$	1.65V to 3.6V	2.3V to 5.5V	Full			0.3	V			
V _{OHB}	Port B Output High Voltage	$I_{OH} = -20 \mu A$ $V_{IA} \ge V_{CCA} - 0.4 V$	1.65V to 3.6V	2.3V to 5.5V	Full	V _{CCA} ×0.7			V			
V _{OLB}	Port B Output Low Voltage	$I_{OL}=1mA$ $V_{IA} \le 0.15 \text{ V}$	1.65V to 3.6V	2.3V to 5.5V	Full			0.3	V			
l _i	Input Leakage	OE	1.65V to 3.6V	2.3V to 5.5V	+25 ℃			±1	μA			
	Current				Full			±1.5				
	D - whi - l	A Ports	0V	0V to 5.5V	+25℃			±0.5				
l _{off}	Partial Power				Full			±1	μA			
юп	Down Current	B Ports	0V to 3.6V	0V	+25 ℃			±0.5	μΛ			
		B i one			Full			±1				
loz	High-impedance	A or B port	A or B port 1.65V to 3.6	1.65V to 3.6V	2.3V to 5.5V	+25℃			±0.5	μA		
IOZ	State Output Current	OE=0V	1.050 to 5.00	2.3 0 10 3.3 0	Full			±1	μΑ			
			1.65V to V _{CCB}	2.3v to 5.5V	Full			2.5				
I _{CCA}	V _{CCA} Supply Current				V _I =VO=open I _O =0	3.6v	0V	Full			2.5	μA
			0v	5.5V	Full			-1				
			1.65V to V _{CCB}	2.3v to 5.5V	Full			10				
I _{CCB}	V _{CCB} Supply Current	V _I =V _O =open I _O =0	3.6v	0V	Full			-1	μΑ			
			0v	5.5V	Full			1				
I _{CCA} + I _{CCB}	Combined Supply Current	$V_{I}=V_{CCI}$ or GND $I_{O}=0$	1.65V to V _{CCB}	2.3v to 5.5V	Full			13	μA			
I _{CCZA}	V _{CCA} Supply Current	$V_{I}=V_{CCI}$ or $0V$ $I_{O}=0$, $OE=0V$	1.65V to V _{CCB}	2.3v to 5.5V	Full			1	μA			
Іссzв	V _{CCB} Supply Current	$VI=V_{CCI}$ or $0V$ $I_{O}=0$, $OE=0V$	2.3v to 3.6V	2.3v to 5.5V	Full			1	μΑ			
Ci	Input Capacitance	OE	3.3V	3.3V	+25℃		2.5		pF			
C _{io}	Input-to-output	A Port	3.3V	3.3V	+25℃		5		pF			
	Internal Capacitance	B Port	3.3V	3.3V	+25℃		5		μΓ			

⁽¹⁾ V_{CCI} is the V_{CC} associated with the input port. And V_{CCO} is the V_{CC} associated with the output port.

⁽²⁾ V_{CCA} must be less than or equal to V_{CCB} .



7.2 Timing Requirements

$V_{CCA} = 1.8V \pm 0.15V$

		V_{CCB} =2.5 $V \pm 0.2V$	V_{CCB} =3.3 $V\pm0.2V$	$V_{\text{CCB}} = 5V \pm 0.2V$	
		Тур	Тур	Тур	Unit
Data Rate	Push-pull Driving	21	22	24	
Data Nate	Open-drain Driving	2	2	2	Mbps
Pulse Duration(tw)	Push-pull Driving (Data Inputs)	47	45	41	ne
()	Open-drain Driving (Data Inputs)	500	500	500	ns

$V_{CCA}=2.5V \pm 0.15V$

		$V_{CCB}=2.5V\pm0.2V$	$V_{CCB}=3.3V\pm0.2V$	$V_{CCB}=5V\pm0.2V$	
		Тур	Тур	Тур	Unit
Data Rate	Push-pull Driving	20	22	24	
Data Nate	Open-drain Driving	2	2	2	Mbps
Pulse Duration(tw)	Push-pull Driving (Data Inputs)	50	45	41	ns
	Open-drain Driving (Data Inputs)	500	500	500	115

$V_{CCA}=3.3V \pm 0.15V$

		V _{CCB} =3.3V±0.2V	V _{CCB} =5V±0.2V	
		Тур	Тур	Unit
	Push-pull Driving	23	24	
Data Rate	Open-drain Driving	2	2	Mbps
	Push-pull Driving (Data Inputs)	43	41	
Pulse Duration(tw)	Open-drain Driving (Data Inputs)	500	500	ns



4-Bit Bidirectional Voltage-Level Translator

7.3 Switching Characteristics: V_{CCA}=1.8V±0.15V

over recommended operating free-air temperature range (unless otherwise noted)

D		Conditions		$V_{\texttt{CCB}}$ =2.5 $V\pm0.2V$	V_{CCB} =3.3 $V\pm0.2V$	V_{CCB} =5 $V\pm0.2V$	
Pa	irameter	Con	iditions	Тур	Тур	Тур	Units
	Propagation Delay Time		Push-pull Driving	5.6	5	5	
t _{PHL}	High-to-low Output	A to B	Open-drain Driving	7.5	7.9	8.3	ns
tрLн	Propagation Delay Time	A to B	Push-pull Driving	10.0	9.5	9	ns
IPLH	low-to-high Output	Alob	Open-drain Driving	181	170	154	113
tрнL	Propagation Delay Time	B to A	Push-pull Driving	7	7.1	7.2	ns
	High-to-low Output		Open-drain Driving	7.6	8.1	9.2	
	Propagation Delay Time		Push-pull Driving	7.6	6.9	6	
tpLH	low-to-high Output	B to A	Open-drain Driving	163	145	118	ns
ten	Enable Time	OE	E to A or B	135	159	182	ns
tdis	Disable Time	OE	E to A or B	170	174	181	ns
			Push-pull Driving	13.4	11.9	10.6	
trA	Input Rise Time	A port rise time	Open-drain Driving	68	66	62	ns
		. .	Push-pull Driving	13	12	11.6	
t _{rB}	Input Rise Time	B port rise time	Open-drain Driving	66	65	50	ns
			Push-pull Driving	5.6	4.7	4.0	
tfA	Input Fall Time	A port fall time	Open-drain Driving	5.0	5.1	5.2	ns
			Push-pull Driving	3.0	3.0	2.9	
t _{fB}	Input Fall Time	B port fall time	Open-drain Driving	6.1	5.6	4.4	ns
tsk(o)	Skew(time), Output	Channel-	to-Channel Skew	0.5	0.5	0.5	ns
Max	imum Data Rate	Push	n-pull Driving	22	23	24	Mbps
		Open	-drain Driving	2	2	2	



4-Bit Bidirectional Voltage-Level Translator

7.4 Switching Characteristics, V_{CCA}=2.5V±0.15V

over operating free-air temperature range (unless otherwise noted)

	arameter	Conditions		V_{CCB} =2.5 $V\pm0.2V$	V_{CCB} =3.3 $V \pm 0.2V$	$V_{CCB}=5V\pm0.2V$	/
Г	arameter	Cor	iuitions	Тур	Тур	Тур	Units
tрнL	Propagation Delay Time	A to B	Push-pull Driving	3.5	3.5	3.2	ns
	High-to-low Output	7110 2	Open-drain Driving	6.3	6.5	6.7	
tрLн	Propagation Delay Time	A to B	Push-pull Driving	4.5	4.9	4.7	ns
LFLH	low-to-high Output	Alob	Open-drain Driving	158	152	142	113
	Propagation Delay Time	D to A	Push-pull Driving	3.7	3.9	4.6	
t _{PHL}	High-to-low Output	B to A	Open-drain Driving	6	6.6	7.7	ns
	Propagation Delay Time		Push-pull Driving	4.8	4	2.5	
t _{PLH}	low-to-high Output	B to A	Open-drain Driving	153	138	116	ns
ten	Enable Time	OE	E to A or B	7.7	41.8	130	ns
tdis	Disable Time	OE	E to A or B	175	181	182	ns
			Push-pull Driving	9.8	8.6	7.5	
trA	Input Rise Time	A port Rise Time	Open-drain Driving	79	77	65	ns
			Push-pull Driving	9.8	8.7	8.1	
trв	Input Rise Time	B port Rise Time	Open-drain Driving	93	68	53	ns
		A port	Push-pull Driving	4.6	4.1	3.6	
tfA	Input Fall Time	A port Fall Time	Open-drain Driving	5.1	5.1	5.2	ns
			Push-pull Driving	4.5	4.0	4.0	
tғв	Input Fall Time	B port Fall Time	Open-drain Driving	6.9	7.4	7.8	ns
tsĸ(o)	Skew(time), Output	Channel-	to-Channel Skew	0.5	0.5	0.5	ns
Max	kimum Data Rate	Push	n-pull Driving	22	24	24	Mbps
		Open	-drain Driving	2	2	2	



4-Bit Bidirectional Voltage-Level Translator

7.5 Switching Characteristics, VCCA=3.3V±0.3V

over recommended operating free-air temperature range (unless otherwise noted)

	Parameter		nditions	$V_{\text{CCB}}=3.3V\pm0.2V$	$V_{\text{CCB}}=5V\pm0.2V$		
•	Parameter	Conditions		TYP	TYP	Units	
+	Propagation Delay Time	A to B	Push-pull Driving	2.1	2.2	ns	
tphL	High-to-low Output	AIOB	Open-drain Driving	5.9	6.1	115	
	Propagation Delay Time	A to B	Push-pull Driving	1	3.3	ns	
t _{PLH}	High-to-low Output	ALOB	Open-drain Driving	138	131	115	
tpHL	Propagation Delay Time	B to A	Push-pull Driving	2.3	2.6	ns	
TPHL	High-to-low Output	BIOA	Open-drain Driving	5.4	6.6	113	
	Propagation delay time	D 4- A	Push-pull Driving	1.0	1.0		
tpLH	low-to-high Output	B to A	Open-drain Driving	133	115	ns	
t _{en}	Enable Time	0	E to A or B	4.7	5.2	ns	
t _{dis}	Disable Time	0	E to A or B	174	182	ns	
	D: T:	A port	Push-pull Driving	7.4	6.6		
t _{rA}	Input Rise Time	Rise Time	Open-drain Driving	75	67	ns	
		B port	Push-pull Driving	7.7	7.1		
t _{rB}	Input Rise Time	Rise Time	Open-drain Driving	70	65	ns	
	Innut Fall Times	A port Fall	Push-pull Driving	3.4	3.0		
t _{fA}	Input Fall Time	Time	Open-drain Driving	5.1	5.1	ns	
+_	Input Fall Time	B port Fall	Push-pull Driving	3.5	3.2		
t _{fB}	Input Fall Time	Time	Open-drain Driving	6.8	6.7	ns	
tsk(o)	Skew(time), Output	Channel	-to-Channel Skew	0.5	0.5	ns	
Max	kimum Data Rate	Pus	h-pull Driving	24	24	Mbps	
		Oper	n-drain Driving	2	2	, , , , , ,	



8 Typical Characteristics

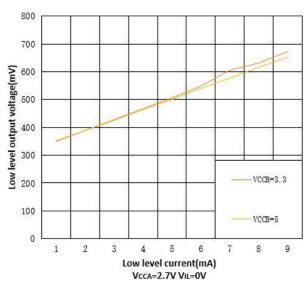


Fig.8-1. Low Level Output Voltage vs Low Level Current

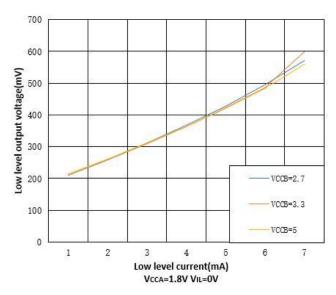


Fig.8-2. Low Level Output Voltage vs Low Level Current

9 Parameter Measurement Information

Unless otherwise noted, all input pulsed are supplied by generators having the following characteristics:

- PSRR 10MHz
- Zo=50 Ω
- dv/dt ≥1V/ns

Note: All input pulses are measured one at a time with one transition per measurement

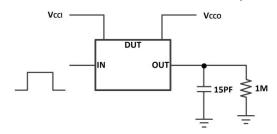


Fig.9-1. Data Rate, Pulse Duration, Propagation Delay, Output Rise and Fall Time Measurement Using a Push-Pull Driver

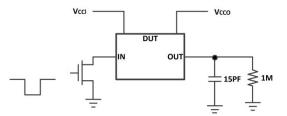


Fig.9-2. Data Rate, Pulse Duration, Propagation Delay, Output Rise and Fall Time Measurement Using an Open-Drain Driver

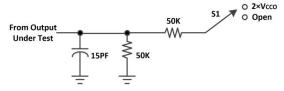


Fig.9-3. Load Circuit for Enable/Disable Time Measurement

Table 9-1 Switch Configuration for Enable/Disable Timing

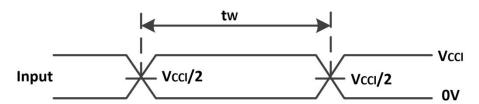
Test	S1
t _{PZL} ⁽¹⁾ , t _{PLZ} ⁽²⁾	2×V _{cco}
t _{PZH} ⁽¹⁾ , t _{PHZ} ⁽²⁾	Open

⁽¹⁾ t_{PZL} and t_{PZH} are the same as t_{en} .

⁽²⁾ t_{PLZ} and t_{PHZ} are the same as t_{dis} .



9 Parameter Measurement Information(Continued)



(1) All input pulses are measured one at a time, with one transition per measurement.

Fig.9-4. Voltage Waveforms Pulse Duration

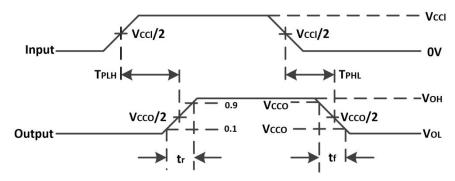


Fig.9-5. Voltage Waveforms Propagation Delay Times

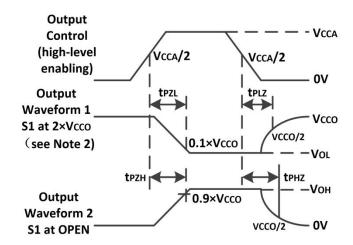


Fig.9-6. Voltage Waveforms Enable and Disable



10 Detailed Description

10.1 Overview

The WB0104 IC is a Bi-direction voltage-level translator specifically designed for translating logic voltage levels. The A port can accept I/O voltages that cover from 1.65 V to 3.6 V range; The B port can accept I/O voltages from 2.3 V to 5.5 V. The device is a pass-gate architecture with edge-rate accelerators (one-shots) to improve the overall data rate. $10-k\Omega$ pullup resistors that usually used in open-drain applications have been integrated inside IC with the advantage saving an external resistor. Not only the IC is designed for open-drain applications, but also this device can translate push-pull CMOS logic outputs.

10.2 Architecture

The WB0104 architecture (see Figure below) is a translator with Bi-direction-Sensing function that means a direction- control mechanism to control the direction of data flow from A to B or from B to A is not needed. These two bidirectional channels independently determine the direction of data flow without a direction-control signal. This auto- direction feature is realized by each I/O pin can be automatically reconfigured as either an input or an output.

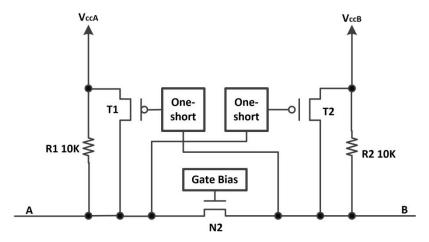


Fig.10-1. Architecture of WB0104

11 Application Information

The WB0104 device can be used to bridge the digital-switching compatibility gap between two voltage nodes to successfully interface logic threshold levels found in electronic systems. It should be used in a point-to-point topology for interfacing devices or systems operating at different interface voltages with one another. Its primary target application use is for interfacing with open-drain drivers on the data I/Os such as I2C or 1-wire, where the data is bidirectional and no control signal is available. The device can also be used in applications where a push-pull driver is connected to the data I/Os, but the WB0104 might be a better option for such push-pull applications.

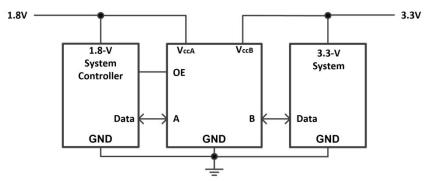
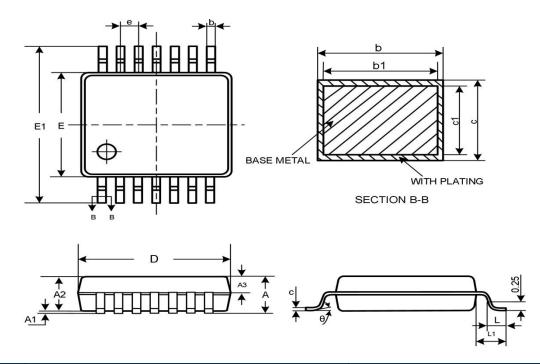


Fig.11-1. Typical Application Schematic

12 Package Outline Dimension

TSSOP14



Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min	Nom	Max	Min	Nom	Max
Α	-	-	1.20	-	-	0.047
A1	0.05	-	0.15	0.002	-	0.006
A2	0.90	1.00	1.05	0.035	0.039	0.041
A3	0.39	0.44	0.49	0.015	0.017	0.019
b	0.20	-	0.28	0.008	-	0.011
b1	0.19	0.22	0.25	0.007	0.009	0.010
С	0.13	-	0.17	0.005	-	0.007
c1	0.12	0.13	0.14	0.005	0.005	0.006
D	4.90	5.00	5.10	0.193	0.197	0.201
E	4.30	4.40	4.50	0.169	0.173	0.177
E1	6.20	6.40	6.60	0.244	0.252	0.260
е	0.65BSC			0.026BSC		
L	0.45	0.60	0.75	0.018	0.024	0.030
L1	1.00BSC			0.039BSC		
θ	0	-	8°	0	-	8°



4-Bit Bidirectional Voltage-Level Translator

Notes For Attention

- When making the purchase, please ensure you recognize the company's trademark. If you have any questions, please contact the company's headquarters.
- When designing the circuit, please do not exceed the absolute maximum ratings of the components; otherwise, it will affect the reliability of the entire machine.
- > This manual may be subject to changes in version without further notice.
- WaferBest assumes no obligation for application assistance or customer product design. The provided design solutions and materials are for reference only. Customers are responsible for the use of our products and applications by themselves. To minimize risks related to customer products and applications, customers should conduct thorough design verification, small-scale trial production, large-scale trial production, and operational safety measures.